

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|---------------------|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | Vrrm Vrwm Vr | 40 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 28 | V |
| Average Forward Current | l _{F(AV)} | 1.0 | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | IFSM | 50 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|------------------|-------------|------|
| Power Dissipation (Note 5) | PD | 550 | mW |
| Power Dissipation (Note 6) | PD | 820 | mW |
| Thermal Resistance Junction to Soldering Point (Note 7) | Rejs | 10 | °C/W |
| Thermal Resistance Junction to Ambient (Note 5) | RθJA | 180 | °C/W |
| Thermal Resistance Junction to Ambient (Note 6) | $R_{	heta JA}$ | 120 | °C/W |
| Operating Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | T _{STG} | -55 to +150 | °C |

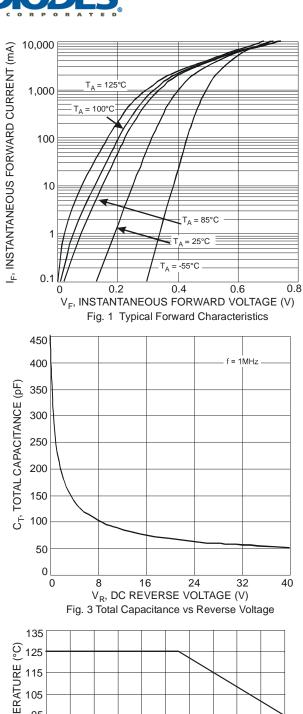
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

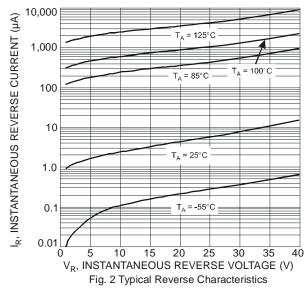
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|----------------|-----|-----|---|------|--|
| Reverse Breakdown Voltage (Note 8) | $V_{(BR)R}$ | 40 | | _ | V | $I_R = 500 \mu A$ |
| Forward Voltage | VF | | | 0.36 0.30 0.55 0.515 0.85 0.88 | ٧ | $\begin{split} & _F = 0.1\text{A}, T_J = +25^{\circ}\text{C} \\ & _F = 0.1\text{A}, T_J = +85^{\circ}\text{C} \\ & _F = 1.0\text{A}, T_J = +25^{\circ}\text{C} \\ & _F = 1.0\text{A}, T_J = +85^{\circ}\text{C} \\ & _F = 3.0\text{A}, T_J = +25^{\circ}\text{C} \\ & _F = 3.0\text{A}, T_J = +85^{\circ}\text{C} \end{split}$ |
| Leakage Current (Note 8) | I _R | | | 0.1 10 0.05 5 | mA | VR = 40V, TJ = +25°C VR = 40V, TJ = +85°C VR = 20V, TJ = +25°C VR = 20V, TJ = +85°C |
| Total Capacitance | Ст | _ | 90 | _ | pF | $V_R = 10V, f = 1.0MHz$ |

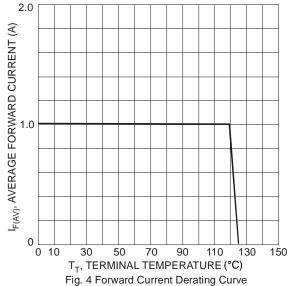
Notes:

- 5. 1*MRP FR-4 PC board,2oz.copper PCB board.
- 6. 1inch sq. copper pad, 2oz. PCB board.
- 7. Theoretical Reus calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 8. Short duration pulse test to minimize self-heating effect.









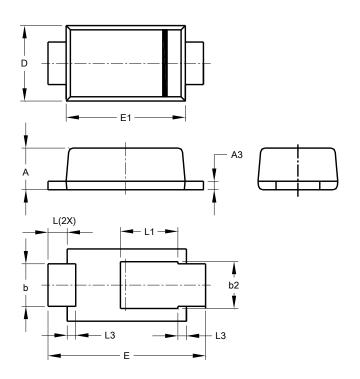
135 © 125 H 115 105 H 2 105 H 3 115 H 3 115 H 4 105 H 3 115 H 4 105 H 5 10



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123

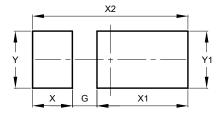


| PowerDI123 | | | | |
|----------------------|-------|-------|------|--|
| Dim | Min | Max | Тур | |
| Α | 0.93 | 1.00 | 0.98 | |
| A3 | 0.15 | 0.25 | 0.20 | |
| b | 0.85 | 1.25 | 1.00 | |
| b2 | 1.025 | 1.125 | 1.10 | |
| D | 1.63 | 1.93 | 1.78 | |
| Е | 3.50 | 3.90 | 3.70 | |
| E1 | 2.60 | 3.00 | 2.80 | |
| L | 0.40 | 0.50 | 0.45 | |
| L1 | 1.25 | 1.40 | 1.35 | |
| L3 | 0.125 | 0.275 | 0.20 | |
| All Dimensions in mm | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



| Dimensions | Value (in mm) | | |
|------------|------------------|--|--|
| G | 0.65 | | |
| Х | 1.05 | | |
| X1 | 2.40 | | |
| X2 | 4.10 | | |
| Y | 1.50 | | |
| Y1 | 1.50 | | |



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